



<b>Title of Change:</b>	Change of inner box design.
<b>Proposed first ship date:</b>	1 June 2015
<b>Contact information:</b>	<Rowena.Naigar@onsemi.com><Hiroshi2.Kobayashi@onsemi.com> <Dennis.Balignasay@onsemi.com>
<b>Type of notification:</b>	ON Semiconductor considers this change approved unless specific conditions of acceptance are provided in writing. To do so, contact <PCN.Support@onsemi.com>.

<b>Change category(s):</b> <input type="checkbox"/> Wafer Fab Change <input type="checkbox"/> Manufacturing Site Change/Addition <input type="checkbox"/> Assembly Change <input type="checkbox"/> Manufacturing Process Change <input type="checkbox"/> Test Change <input type="checkbox"/> Material Change		<input type="checkbox"/> Product specific change <input type="checkbox"/> Datasheet/Product Doc change <input checked="" type="checkbox"/> Shipping/Packaging/Marking <input type="checkbox"/> Other: _____
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<b>Sites Affected:</b> <input type="checkbox"/> All site(s) <input type="checkbox"/> not applicable <input checked="" type="checkbox"/> ON Semiconductor site(s) : <input type="checkbox"/> External Foundry/Subcon site(s):	<b>Site 1</b> ON Tarlac City, Philippines	<b>Site 2</b>
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**Description and Purpose:**

Change in Inner box design as part of the integration into the packing material of ON Semi specification.

**BASIC BOX DIMENSION COMPARISON**

	CURRENT				PROPOSED
	BOX(TE-2412)		BOX(SMP)		ON Semi Pizza Box
Length	350 mm	17 mm	350 mm	17 mm	333 mm
Width	337 mm	16 mm	335 mm	18 mm	353 mm
Height	36 mm	13 mm	47 mm	2 mm	49 mm

**Actual**

**List of affected Standard Parts:**

Please see attached excel file for the list of affected standard parts.

*To access file attachments on pdf copy of PCN, please be guided by the steps below:*

1. Download pdf copy of the PCN to your computer
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3. Click on the paper clip icon available on the menu provided in the left/bottom portion of the screen to reveal the Attachment field
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